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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-case thermal resistance	R _{eJC}	6	°C/W		

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	UGF1004G	I _F = 5A, T _J = 25°C	V _F	1	0.95	V
	UGF1005G UGF1006G			-	1.25	V
	UGF1007G UGF1008G			-	1.70	V
5 (2)		T _J = 25°C		-	10	μA
Reverse current @ rated V _R per o	iode, ,	T _J = 125°C	I _R	-	100	μA
Reverse recovery time	UGF1004G UGF1005G UGF1006G	$I_F = 0.5A$, $I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	20	ns
	UGF1007G UGF1008G			-	25	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING		
UGF10xG	ITO-220AB	50 / Tube		
UGF10xGH	ITO-220AB	50 / Tube		

Notes:

- 1. "x" defines voltage from 200V(UGF1004G) to 600V(UGF1008G)
- 2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

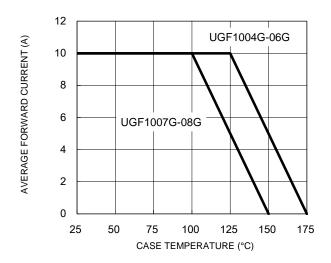


Fig.2 Typical Junction Capacitance

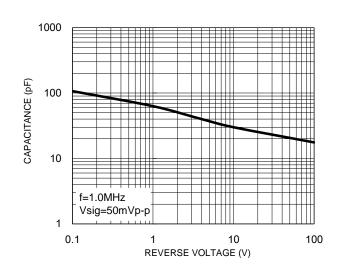
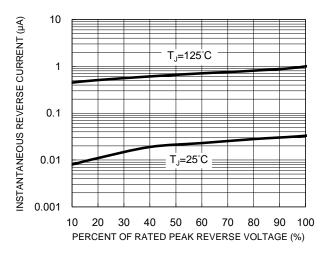


Fig.3 Typical Reverse Characteristics





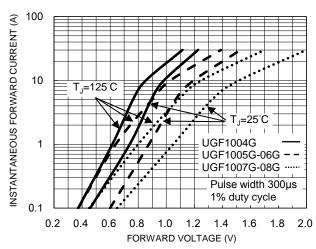
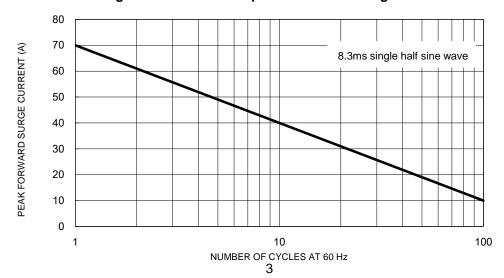


Fig.5 Maximum Non-Repetitive Forward Surge Current

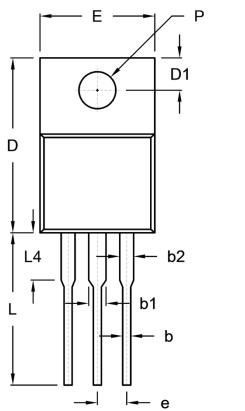


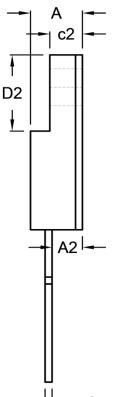


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PACKAGE OUTLINE DIMENSIONS

ITO-220AB





DIM	Unit (mm)		Unit (inch)		
DIM.	Min.	Max.	Min.	Max.	
Α	4.30	4.70	0.169	0.185	
A2	2.30	2.96	0.091	0.117	
b	0.50	0.90	0.020	0.035	
b1	-	1.80	-	0.071	
b2	0.95	1.45	0.037	0.057	
С	0.46	0.76	0.018	0.030	
c2	2.50	3.16	0.098	0.124	
D	14.80	15.50	0.583	0.610	
D1	2.40	3.20	0.094	0.126	
D2	6.30	6.90	0.248	0.272	
E	9.60	10.30	0.378	0.406	
е	2.41	2.67	0.095	0.105	
L	12.60	13.80	0.496	0.543	
L4	-	4.10	-	0.161	
Р	3.00	3.40	0.118	0.134	

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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